Quad single-pole single-throw analog switch Rev. 8 — 11 September 2014

Product data sheet

#### 1. **General description**

The HEF4066B provides four single-pole, single-throw analog switch functions. Each switch has two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When nE is LOW, the analog switch is turned off.

The HEF4066B is pin compatible with the HEF4016B but exhibits a much lower ON resistance. In addition the ON resistance is relatively constant over the full input signal range.

#### **Features and benefits** 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Inputs and outputs are protected against electrostatic effects
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

## 3. Applications

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

#### **Ordering information** 4.

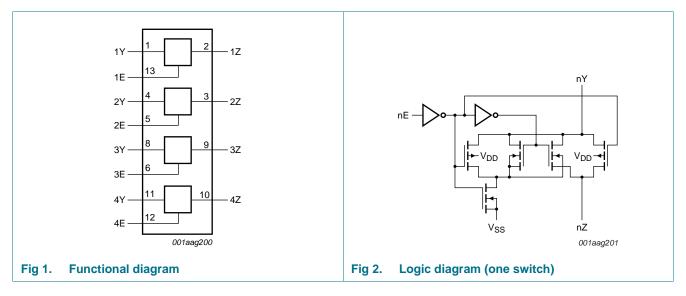
#### Table 1. **Ordering information**

Type number Package							
	Temperature range	Name	Description	Version			
HEF4066BP	–40 °C to +125 °C	DIP14	plastic dual in-line package; 14 leads (300 mil)	SOT27-1			
HEF4066BT	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1			



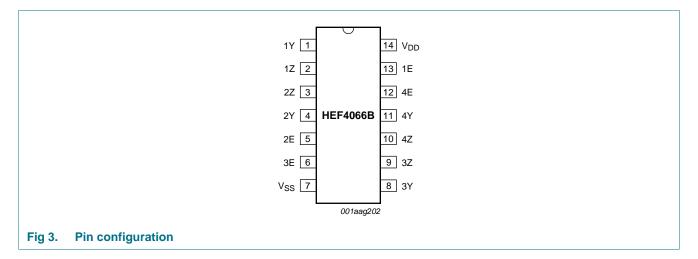
Quad single-pole single-throw analog switch

## 5. Functional diagram



## 6. Pinning information

## 6.1 Pinning



### 6.2 Pin description

Table 2.   Pin descriptio	n		
Symbol	Pin	Description	
1Y, 2Y, 3Y, 4Y	1, 4, 8, 11	independent input or output	
1Z, 2Z, 3Z, 4Z	2, 3, 9, 10	independent input or output	
1E, 2E, 3E, 4E	13, 5, 6, 12	enable input (active HIGH)	
V <sub>SS</sub>	7	ground (0 V)	
V <sub>DD</sub>	14	supply voltage	

HEF4066B Product data sheet © NXP Semiconductors N.V. 2014. All rights reserved.

## 7. Functional description

Table 3.   Function table <sup>[1]</sup>	
Input nE	Switch
н	ON
L	OFF

[1] H = HIGH voltage level; L = LOW voltage level.

### 8. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 V$  (ground).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DD</sub>	supply voltage			-0.5	+18	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{DD} + 0.5 \text{ V}$		-	±10	mA
VI	input voltage			-0.5	V <sub>DD</sub> + 0.5	V
I <sub>I/O</sub>	input/output current		<u>[1]</u>	-	±10	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
T <sub>amb</sub>	ambient temperature			-40	+85	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$				
		DIP14	[2]	-	750	mW
		SO14	[3]	-	500	mW
Р	power dissipation	per switch		-	100	mW

[1] To avoid drawing V<sub>DD</sub> current out of terminal nZ, when switch current flows into terminals nY, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no V<sub>DD</sub> current will flow out of terminals nY, in this case there is no limit for the voltage drop across the switch, but the voltages at nY and nZ may not exceed V<sub>DD</sub> or V<sub>SS</sub>.

[2] For DIP14 packages: above  $T_{amb}$  = 70 °C, P<sub>tot</sub> derates linearly with 12 mW/K.

[3] For SO14 packages: above  $T_{amb} = 70 \text{ °C}$ ,  $P_{tot}$  derates linearly with 8 mW/K.

## 9. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DD</sub>	supply voltage		3	-	15	V
VI	input voltage		0	-	V <sub>DD</sub>	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall	$V_{DD} = 5 V$	-	-	3.75	μs/V
rate	rate	V <sub>DD</sub> = 10 V	-	-	0.5	μs/V
		V <sub>DD</sub> = 15 V	-	-	0.08	μs/V

#### Table 5. Recommended operating conditions

#### Quad single-pole single-throw analog switch

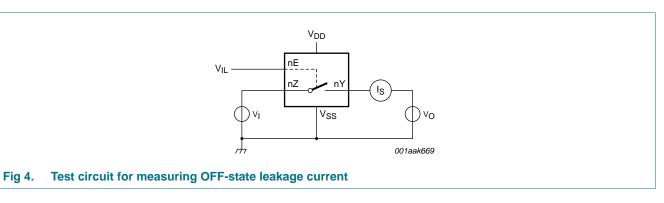
## **10. Static characteristics**

#### Table 6. Static characteristics

 $V_{SS} = 0$  V;  $V_{I} = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> =	<b>−40</b> °C	T <sub>amb</sub> =	= 25 °C	T <sub>amb</sub> =	= 85 °C	T <sub>amb</sub> =	125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>IH</sub>	HIGH-level	I <sub>O</sub>   < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V <sub>IL</sub>	LOW-level	I <sub>O</sub>   < 1 μA	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
l <sub>l</sub>	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>S(OFF)</sub>	OFF-state leakage current	per channel; see <u>Figure 4</u>	15 V	-	-	-	200	-	-	-	-	nA
I <sub>DD</sub>	supply current	all valid input	5 V	-	1.0	-	1.0	-	7.5	-	7.5	μA
		combinations	10 V	-	2.0	-	2.0	-	15.0	-	15.0	μA
			15 V	-	4.0	-	4.0	-	30.0	-	30.0	μA
CI	input capacitance	nE input	-	-	-	-	7.5	-	-	-	-	pF

### 10.1 Test circuit



Quad single-pole single-throw analog switch

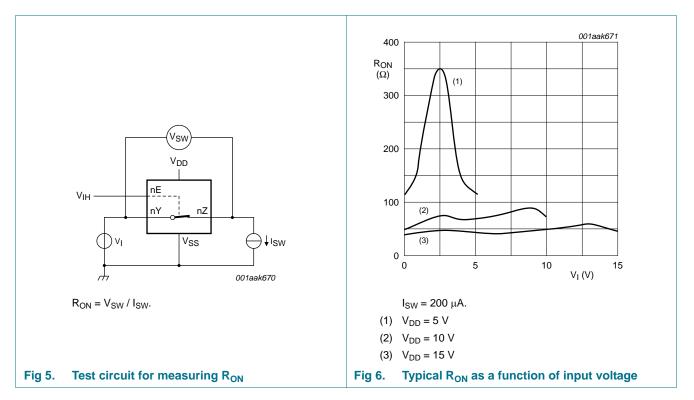
### 10.2 ON resistance

#### Table 7. ON resistance

 $T_{amb} = 25 \ ^{\circ}C; I_{SW} = 200 \ \mu A; V_{SS} = 0 \ V.$ 

Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = 0 V$ to $V_{DD}$ ; see Figure 5 and	5 V	350	2500	Ω
		Figure 6	10 V	80	245	Ω
			15 V	60	175	Ω
R <sub>ON(rail)</sub> ON resistance (rail)		$V_I = 0 V$ ; see Figure 5 and Figure 6	5 V	115	340	Ω
			10 V	50	160	Ω
			15 V	40	115	Ω
		$V_I = V_{DD}$ ; see <u>Figure 5</u> and <u>Figure 6</u>	5 V	120	365	Ω
			10 V	65	200	Ω
			15 V	50	155	Ω
$\Delta R_{ON}$	ON resistance mismatch	$V_I = 0 V$ to $V_{DD}$ ; see Figure 5	5 V	25	-	Ω
	between channels		10 V	10	-	Ω
			15 V	5	-	Ω

### 10.2.1 ON resistance waveform and test circuit



HEF4066B

5 of 16

## **11. Dynamic characteristics**

#### Table 8. Dynamic characteristics

 $T_{amb} = 25 \ ^{\circ}C; V_{SS} = 0 V;$  for test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit
t <sub>PHL</sub>	HIGH to LOW propagation delay	nY, nZ to nZ, nY; see Figure 7	5 V	10	20	ns
			10 V	5	10	ns
			15 V	5	10	ns
		nY, nZ to nZ, nY; see <u>Figure 7</u>	5 V	10	20	ns
			10 V	5	10	ns
			15 V	5	10	ns
t <sub>PHZ</sub>	HIGH to OFF-state	nE to nY, nZ; see <u>Figure 8</u>	5 V	80	160	ns
propagation delay		10 V	65	130	ns	
			15 V	60	120	ns
t <sub>PZH</sub>	OFF-state to HIGH	nE to nY, nZ; see <u>Figure 8</u>	5 V	40	80	ns
	propagation delay		10 V	20	40	ns
			15 V	15	30	ns
t <sub>PLZ</sub>	LOW to OFF-state	nE to nY, nZ; see Figure 8	5 V	80	160	ns
	propagation delay		10 V	70	140	ns
			15 V	70	140	ns
t <sub>PZL</sub>	OFF-state to LOW	nE to nY, nZ; see <u>Figure 8</u>	5 V	45	90	ns
	propagation delay		10 V	20	40	ns
			15 V	15	30	ns

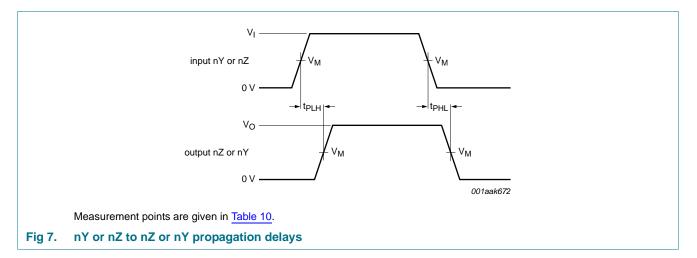
#### Table 9. Dynamic power dissipation P<sub>D</sub>

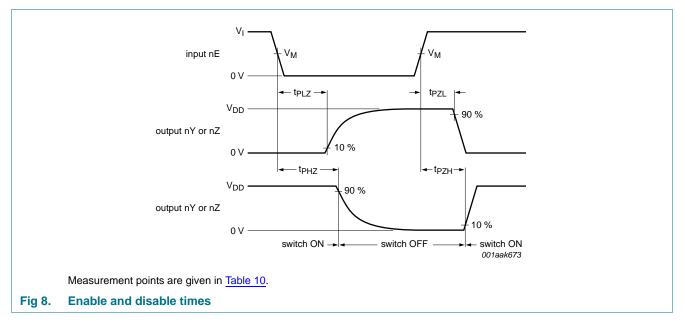
 $P_D$  can be calculated from the formulas shown;  $V_{SS} = 0$  V;  $t_r = t_f \le 20$  ns;  $T_{amb} = 25$  °C.

_				
Symbol	Parameter	V <sub>DD</sub>	Typical formula for $P_D$ ( $\mu$ W)	where:
P <sub>D</sub>	dynamic power	5 V	$P_D = 2500 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	f <sub>i</sub> = input frequency in MHz;
	dissipation	10 V	$P_D = 11500 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	f <sub>o</sub> = output frequency in MHz;
		15 V	$P_{D} = 29000 \times f_{i} + \Sigma(f_{o} \times C_{L}) \times V_{DD}^{2}$	$C_L$ = output load capacitance in pF;
				V <sub>DD</sub> = supply voltage in V;
				$\Sigma(C_L \times f_o)$ = sum of the outputs.

#### Quad single-pole single-throw analog switch

## 11.1 Waveforms and test circuit





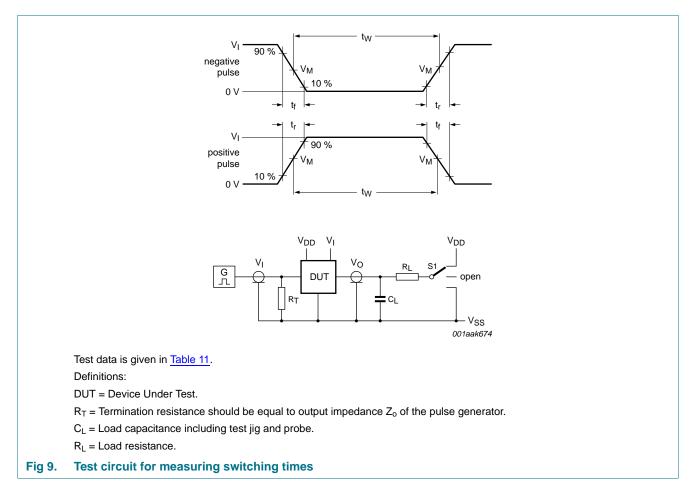
#### Table 10.Measurement points

Supply voltage	Input	Output
V <sub>DD</sub>	V <sub>M</sub>	V <sub>M</sub>
5 V to 15 V	0.5V <sub>DD</sub>	0.5V <sub>DD</sub>

### **NXP Semiconductors**

# **HEF4066B**

#### Quad single-pole single-throw analog switch



#### Table 11. Test data

Supply voltage	Input		Load		S1 position		
V <sub>DD</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
5 V to 15 V	0 V or $V_{DD}$	≤ 20 ns	50 pF	10 kΩ	V <sub>SS</sub>	V <sub>SS</sub>	V <sub>DD</sub>

### 11.2 Additional dynamic parameters

#### Table 12. Additional dynamic characteristics

 $V_{\rm SS}=0$  V;  $T_{amb}=25$  °C.

Symbol	Parameter	Conditions	V <sub>DD</sub>		Тур	Max	Unit
THD	total harmonic distortion	see Figure 10; $R_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ;	5 V	<u>[1]</u>	0.25	-	%
		$f_i = 1 \text{ kHz}$	10 V	<u>[1]</u>	0.04	-	%
			15 V	<u>[1]</u>	0.04	-	%
V <sub>ct</sub>	crosstalk voltage	nE input to switch; see Figure 11; $R_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ; $nE = V_{DD}$ (square-wave)	10 V		50	-	mV

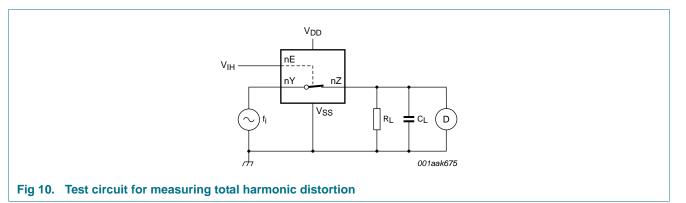
#### Quad single-pole single-throw analog switch

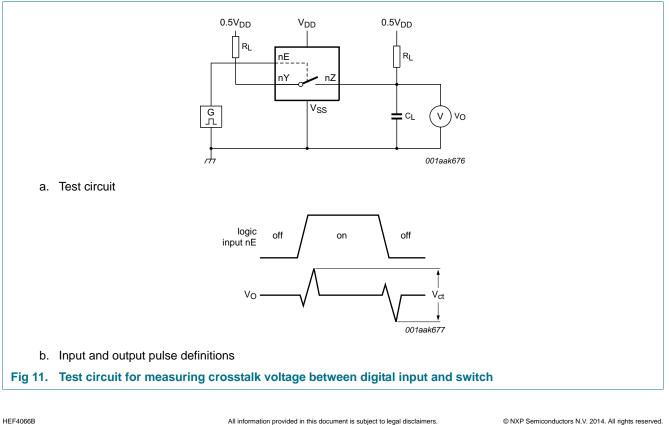
## Table 12. Additional dynamic characteristics ... continued $V_{con} = 0.17$ T $_{con} = 25$ °C

$V_{SS} = 0 V; T_{amb} = 25 °C.$							
Symbol	Parameter	Conditions	V <sub>DD</sub>		Тур	Мах	Unit
Xtalk	crosstalk	between switches; see Figure 12; $f_i = 1 \text{ MHz}; R_L = 1 \text{ k}\Omega;$ $V_I = 0.5V_{DD} \text{ (p-p)}$	10 V	[1]	-50	-	dB
$\alpha_{iso}$	isolation (OFF-state)	see Figure 13; $f_i = 1 \text{ MHz}$ ; $R_L = 1 \text{ k}\Omega$ ; $C_L = 5 \text{ pF}$ ; $V_I = 0.5V_{DD}$ (p-p)	10 V	[1]	-50	-	dB
f <sub>(-3dB)</sub>	-3 dB frequency response	see Figure 14; $R_L = 1 \text{ k}\Omega$ ; $C_L = 5 \text{ pF}$ ; $V_I = 0.5V_{DD} \text{ (p-p)}$	10 V	[1]	90	-	MHz

[1]  $f_i$  is biased at 0.5V<sub>DD</sub>.

### 11.2.1 Test circuits

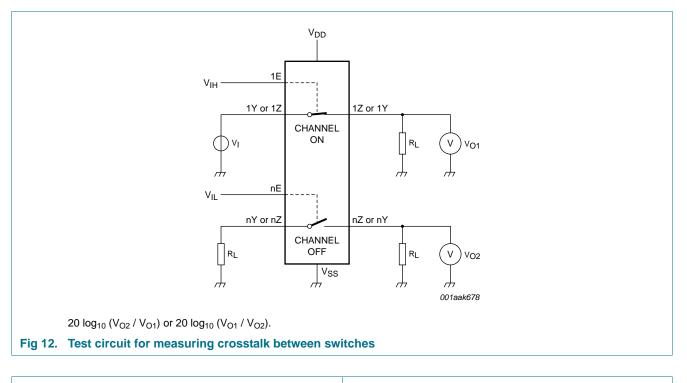


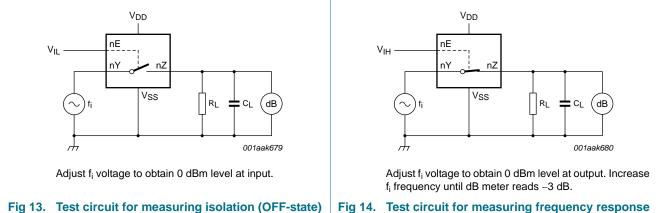


### **NXP Semiconductors**

# **HEF4066B**

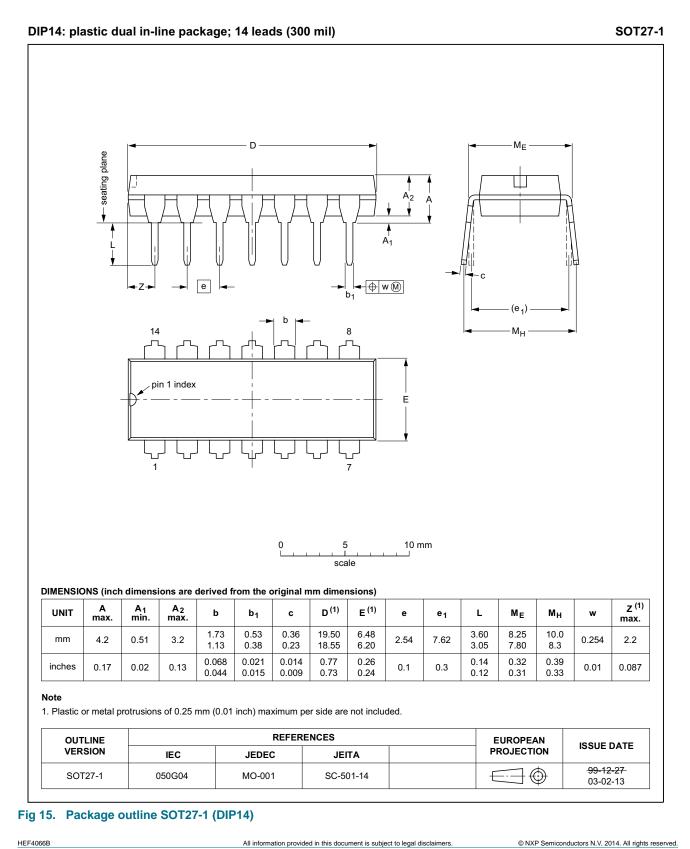
#### Quad single-pole single-throw analog switch





Quad single-pole single-throw analog switch

## 12. Package outline



#### All information provided in this document is subject to legal disclaimers.

Quad single-pole single-throw analog switch

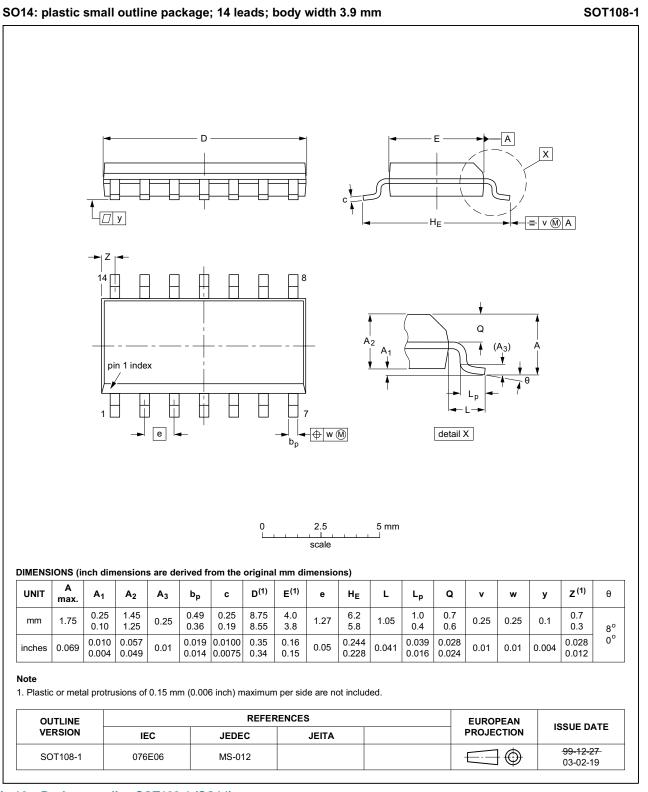


Fig 16. Package outline SOT108-1 (SO14)

## **13. Abbreviations**

Table 13. Abbreviations		
Acronym	Description	
DUT	Device Under Test	

## 14. Revision history

#### Table 14.Revision history

Release date	Data sheet status	Change notice	Supersedes	
20140911	Product data sheet	-	HEF4066B v.7	
• Figure 11: Tes	st circuit modified			
20111116	Product data sheet	-	HEF4066B v.6	
Legal pages updated.				
<ul> <li>Changes in "C</li> </ul>	General description", "Features	and benefits" and "	Applications".	
20100325	Product data sheet	-	HEF4066B v.5	
20100225	Product data sheet	-	HEF4066B v.4	
20091013	Product data sheet	-	HEF4066B_CNV v.3	
19950101	Product specification	-	HEF4066B_CNV v.2	
19950101	Product specification	-	-	
	20140911 • <u>Figure 11</u> : Tes 20111116 • Legal pages u • Changes in "C 20100325 20100225 20091013 19950101	20140911Product data sheetFigure 11: Test circuit modified20111116Product data sheet2011116Product data sheetLegal pages updated.Changes in "General description", "Features20100325Product data sheet20100225Product data sheet20091013Product data sheet19950101Product specification	20140911       Product data sheet       -         • Figure 11: Test circuit modified         20111116       Product data sheet       -         • Legal pages updated.       -         • Changes in "General description", "Features and benefits" and ".         20100325       Product data sheet       -         20100225       Product data sheet       -         20091013       Product data sheet       -         19950101       Product specification       -	

## **15. Legal information**

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

### 15.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof. Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

© NXP Semiconductors N.V. 2014. All rights reserved.

#### Quad single-pole single-throw analog switch

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

### 15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## **16. Contact information**

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

### Quad single-pole single-throw analog switch

## **17. Contents**

1	General description 1
2	Features and benefits 1
3	Applications 1
4	Ordering information 1
5	Functional diagram 2
6	Pinning information 2
6.1	Pinning 2
6.2	Pin description 2
7	Functional description 3
8	Limiting values 3
9	Recommended operating conditions 3
10	Static characteristics 4
10.1	Test circuit
10.2	ON resistance 5
10.2.1	ON resistance waveform and test circuit 5
11	Dynamic characteristics 6
11.1	Waveforms and test circuit
11.2	Additional dynamic parameters 8
11.2.1	Test circuits 9
12	Package outline 11
13	Abbreviations 13
14	Revision history 13
15	Legal information 14
15.1	Data sheet status 14
15.2	Definitions 14
15.3	Disclaimers
15.4	Trademarks 15
16	Contact information 15
17	Contents 16

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

#### © NXP Semiconductors N.V. 2014.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 11 September 2014 Document identifier: HEF4066B